DISCRETE SEMICONDUCTORS

DATA SHEET

BFR93AWNPN 5 GHz wideband transistor

Product specification Supersedes data of November 1992 1995 Sep 18



NPN 5 GHz wideband transistor

BFR93AW

FEATURES

- High power gain
- Gold metallization ensures excellent reliability
- SOT323 (S-mini) package.

APPLICATIONS

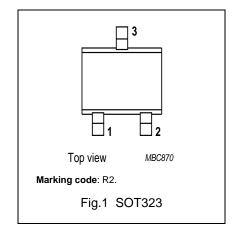
It is designed for use in RF amplifiers, mixers and oscillators with signal frequencies up to 1 GHz.

DESCRIPTION

Silicon NPN transistor encapsulated in a plastic SOT323 (S-mini) package. The BFR93AW uses the same crystal as the SOT23 version, BFR93A.

PINNING

| PIN | DESCRIPTION | |
|-----|-------------|--|
| 1 | base | |
| 2 | emitter | |
| 3 | collector | |



QUICK REFERENCE DATA

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|------------------|-------------------------------|---|------|------|------|------|
| V _{CBO} | collector-base voltage | open emitter | _ | _ | 15 | V |
| V _{CEO} | collector-emitter voltage | open base | _ | _ | 12 | V |
| Ic | collector current (DC) | | _ | _ | 35 | mA |
| P _{tot} | total power dissipation | up to T _s = 93 °C; note 1 | _ | _ | 300 | mW |
| h _{FE} | DC current gain | $I_C = 30 \text{ mA}; V_{CE} = 5 \text{ V}$ | 40 | 90 | _ | |
| C _{re} | feedback capacitance | $I_C = 0$; $V_{CE} = 5 \text{ V}$; $f = 1 \text{ MHz}$; $T_{amb} = 25 \text{ °C}$ | _ | 0.6 | _ | pF |
| f _T | transition frequency | $I_C = 30 \text{ mA}; V_{CE} = 5 \text{ V}; f = 500 \text{ MHz}$ | 4 | 5 | _ | GHz |
| G _{UM} | maximum unilateral power gain | $I_C = 30 \text{ mA}; V_{CE} = 8 \text{ V}; f = 1 \text{ GHz};$ $T_{amb} = 25 \text{ °C}$ | _ | 13 | _ | dB |
| | | $I_C = 30 \text{ mA}; V_{CE} = 8 \text{ V}; f = 2 \text{ GHz}; $ $T_{amb} = 25 \text{ °C}$ | _ | 8 | _ | dB |
| F | noise figure | I_C = 5 mA; V_{CE} = 8 V; f = 1 GHz; $\Gamma_s = \Gamma_{opt}$ | _ | 1.5 | _ | dB |
| T _i | junction temperature | | _ | _ | 150 | °C |

Note

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^{1.} T_{s} is the temperature at the soldering point of the collector pin.

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LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

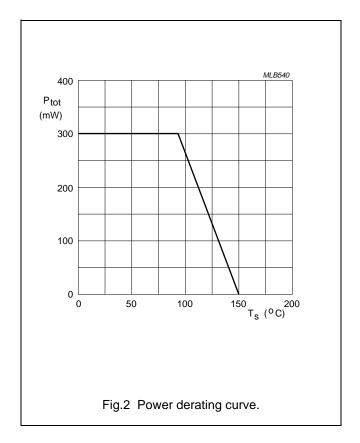
| SYMBOL | PARAMETER | CONDITION | MIN. | MAX. | UNIT |
|------------------|---------------------------|---|------|------|------|
| V _{CBO} | collector-base voltage | open emitter | _ | 15 | V |
| V_{CEO} | collector-emitter voltage | open base | _ | 12 | V |
| V _{EBO} | emitter-base voltage | open collector | _ | 2 | V |
| I _C | collector current (DC) | | _ | 35 | mA |
| P _{tot} | total power dissipation | up to T _s = 93 °C; see Fig.2; note 1 | _ | 300 | mW |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| Tj | junction temperature | | _ | 150 | °C |

THERMAL CHARACTERISTICS

| SYMBOL | PARAMETER | CONDITION | VALUE | UNIT |
|---------------------|---|--------------------------------------|-------|------|
| R _{th j-s} | thermal resistance from junction to soldering point | up to T _s = 93 °C; note 1 | 190 | K/W |

Note to the Limiting values and Thermal characteristics

1. T_s is the temperature at the soldering point of the collector pin.



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CHARACTERISTICS

 $T_j = 25$ °C (unless otherwise specified).

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|------------------|---------------------------------------|--|------|------|------|------|
| I _{CBO} | collector leakage current | I _E = 0; V _{CB} = 5 V | _ | _ | 50 | nA |
| h _{FE} | DC current gain | $I_C = 30 \text{ mA}; V_{CE} = 5 \text{ V}$ | 40 | 90 | _ | |
| C _c | collector capacitance | $I_E = i_e = 0$; $V_{CB} = 5 \text{ V}$; $f = 1 \text{ MHz}$ | - | 0.7 | _ | pF |
| C _e | emitter capacitance | $I_C = I_c = 0$; $V_{EB} = 0.5 \text{ V}$; $f = 1 \text{ MHz}$ | _ | 2.3 | - | pF |
| C _{re} | feedback capacitance | I _C = 0; V _{CE} = 5 V; f = 1 MHz | - | 0.6 | _ | pF |
| f _T | transition frequency | I _C = 30 mA; V _{CE} = 5 V; f = 500 MHz | 4 | 5 | _ | GHz |
| G _{UM} | maximum unilateral power gain; note 1 | $I_C = 30 \text{ mA}; V_{CE} = 8 \text{ V};$ $f = 1 \text{ GHz}; T_{amb} = 25 ^{\circ}\text{C}$ | _ | 13 | - | dB |
| | | I _C = 30 mA; V _{CE} = 8 V; f = 2 GHz; T _{amb} = 25 °C | _ | 8 | - | dB |
| F | noise figure | I_C = 5 mA; V_{CE} = 8 V; f = 1 GHz; Γ_s = Γ_{opt} | _ | 1.5 | - | dB |
| | | I_C = 5 mA; V_{CE} = 8 V; f = 2 GHz; Γ_s = Γ_{opt} | _ | 2.1 | _ | dB |

Note

^{1.} G_{UM} is the maximum unilateral power gain, assuming s_{12} is zero and $G_{UM} = 10 \log \frac{|s_{21}|^2}{(1-|s_{11}|^2)(1-|s_{22}|^2)} dB$.

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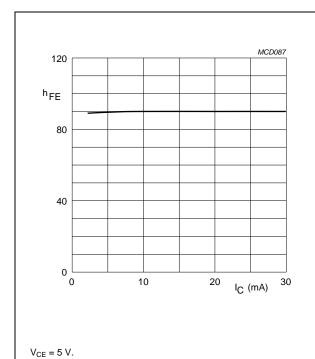


Fig.3 DC current gain as a function of collector current; typical values.

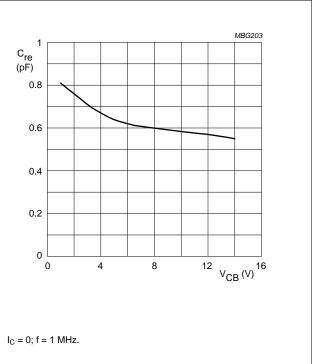
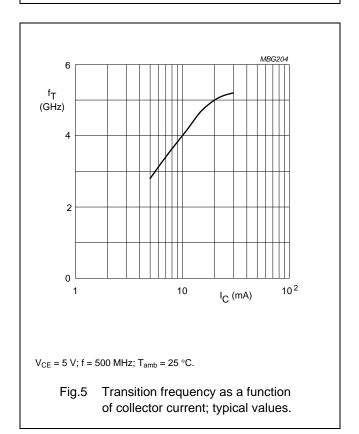


Fig.4 Feedback capacitance as a function of collector-base voltage; typical values.

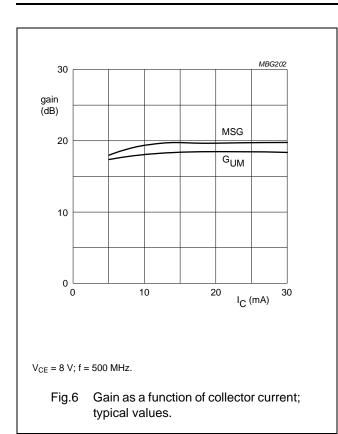


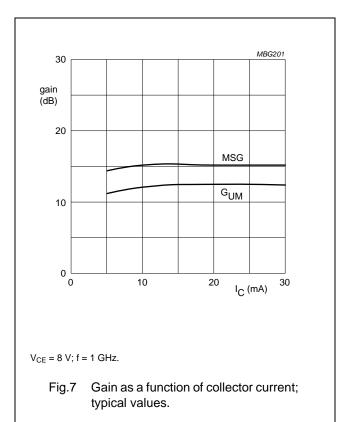
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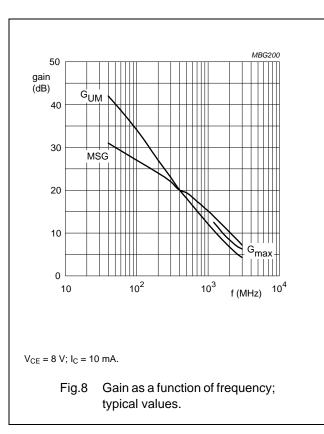
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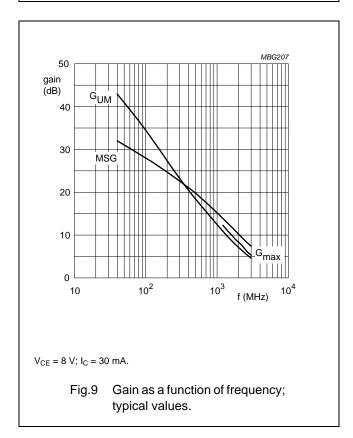
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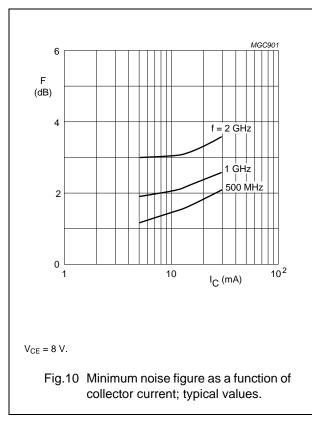


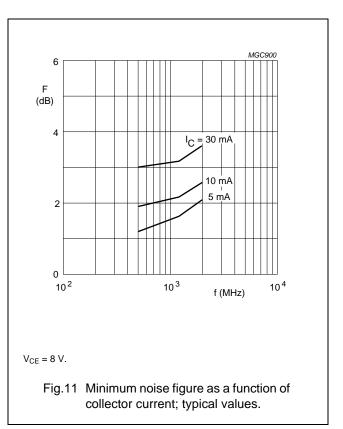


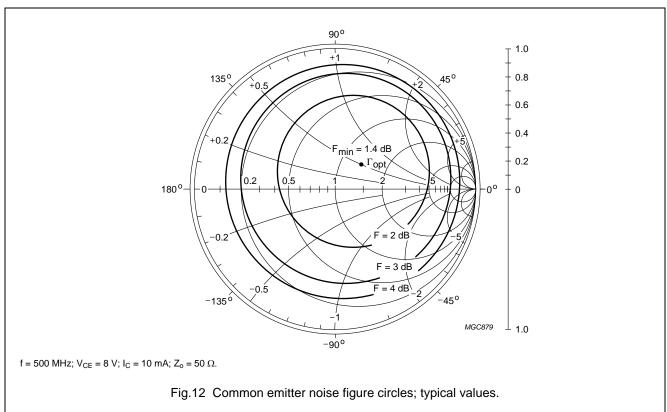


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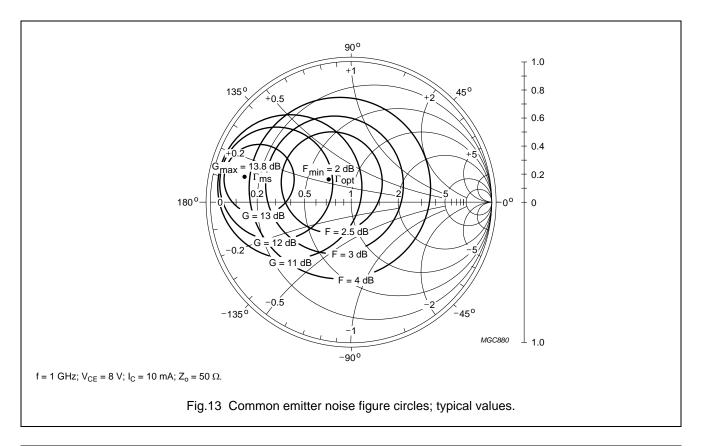


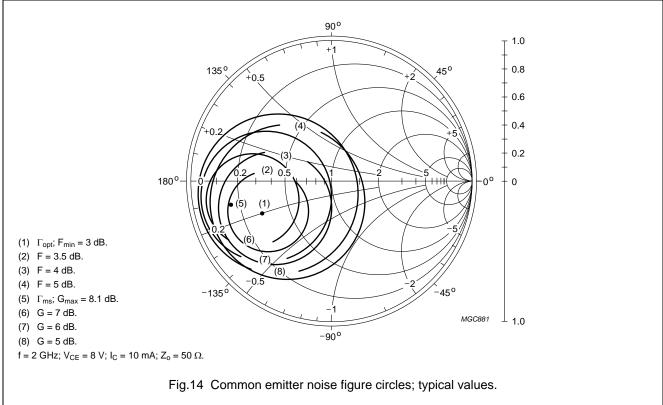




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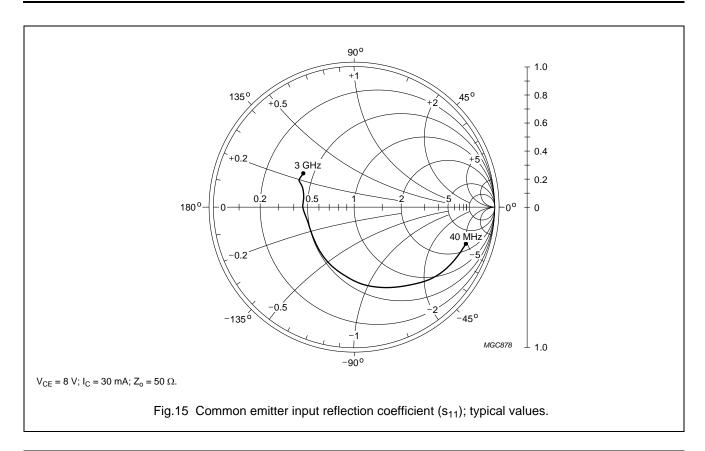
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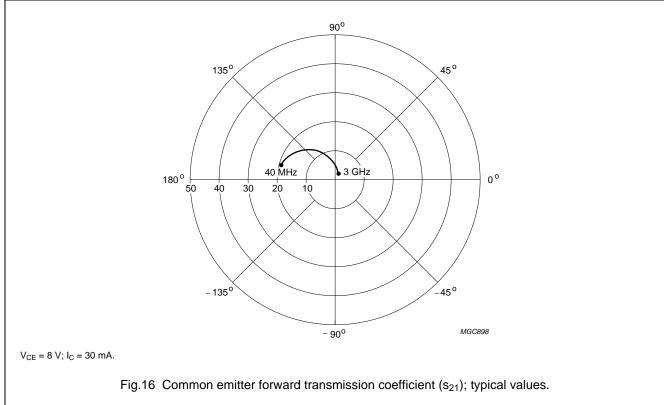




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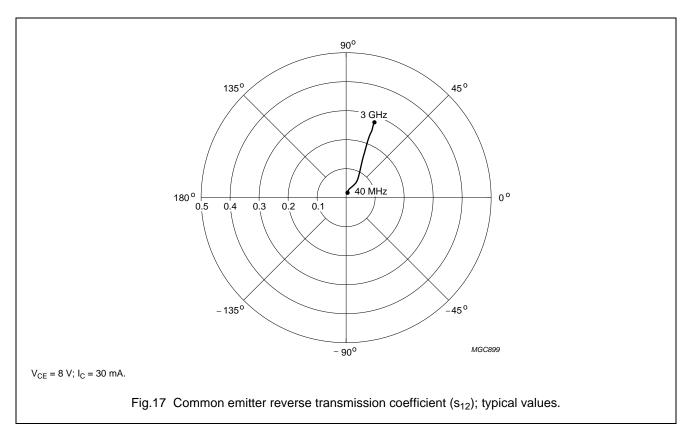


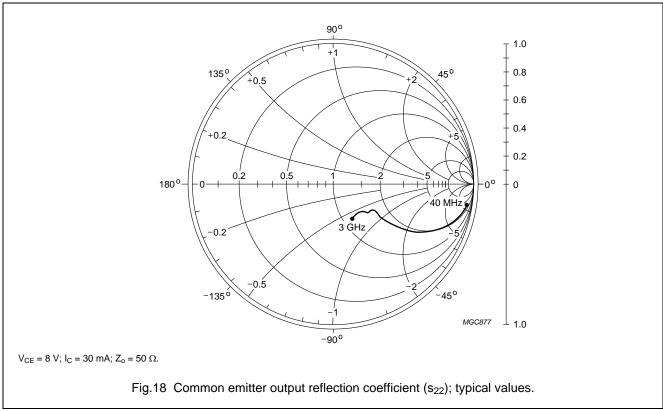
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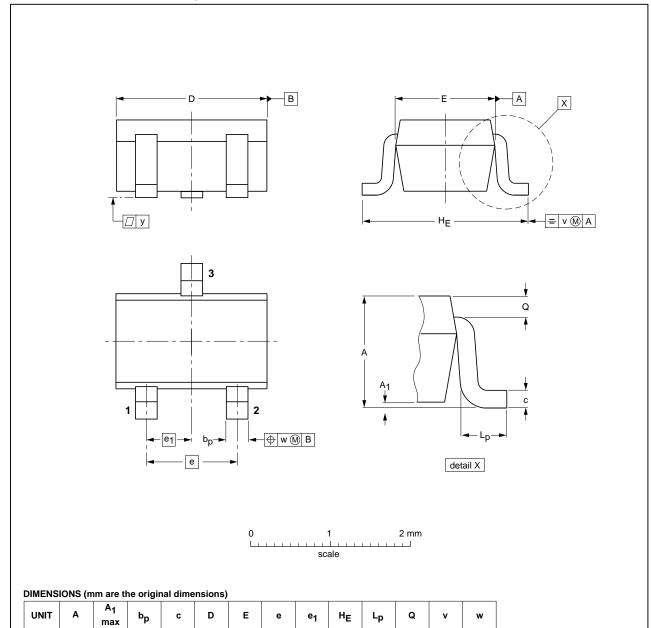
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PACKAGE OUTLINE

Plastic surface-mounted package; 3 leads

SOT323



| OUTLINE | | REFERENCES | | | EUROPEAN ISSUE DATE | |
|---------|-----|------------|-------|--|---------------------|----------------------------------|
| VERSION | IEC | JEDEC | JEITA | | PROJECTION | ISSUE DATE |
| SOT323 | | | SC-70 | | | -04-11-04 06-03-16 |

2.2 2.0

0.65

0.45

0.23

0.2

0.2

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0.4 0.3

0.25

0.10

2.2

1.35

1.3

1.1 0.8

mm

0.1

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DATA SHEET STATUS

| DOCUMENT STATUS ⁽¹⁾ | PRODUCT STATUS ⁽²⁾ | DEFINITION |
|-----------------------------------|----------------------------------|---|
| Objective data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary data sheet | Qualification | This document contains data from the preliminary specification. |
| Product data sheet | Production | This document contains the product specification. |

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